MBRI2X100-180A

SCHOTTKY DIODE MODULE TYPE 2X100A / 180V

Features

High Surge Capability
Type 180V VRRM
Isolation Type Package
Electrically Isolation Base Plate
RoHS Compliant

Maximum Ratings

Junction Operating Temperature : -40°C to +150°C

Storage Temperature : -40°C to +150°C

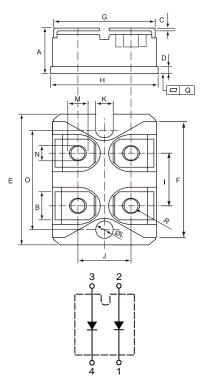
Part Number	Maximum Recurrent Peak Reverse Voltage	Maximum RMS Voltage	Maximum DC Blocking Voltage
MBRI2X100-180A	180V	126V	180V

Electrical Characteristics @ 25°C Unless Otherwise Specified

Average Forward (Per pkg) Current (Per diode)	I _{F(AV)}	200A 100A	Tc=110°C
Peak Forward Surge Current (Per diode)	İFSM	1400A	8.3ms, half sine
Maximum (Per diode) Instantaneous Forward Voltage*	VF	0.82V 0.92V	I _{FM} =100A;T _J =125°C I _{FM} =100A;T _J =25°C
Maximum Instantaneous Reverse Current At Rated DC Blockig Voltage* (Per diode)	lR	3mA 10mA 30mA	T _J =25°C T _J =100°C T _J =150°C
Isolation Voltage	Viso	2500V	A.C. 1 minute
Maximum Thermal Resistance Junction To Case (Per diode)	Røjc	0.40°C/W	
Mounting Torque		1.3Nm	M4 Screw

^{*}Pulse Test: Pulse Width 300 μ sec, Duty Cycle < 2%



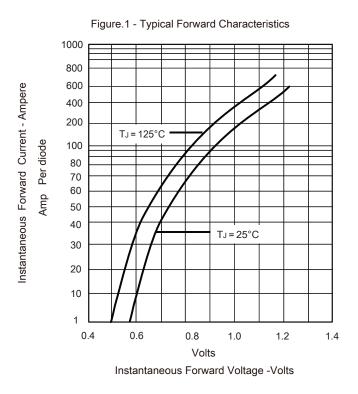


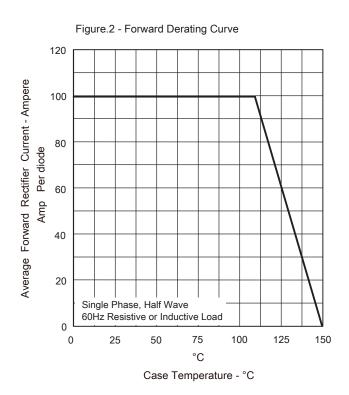
DIMENSIONS							
	INC	HES	MM				
	MIN	MAX	MIN	MAX			
Α	0.460	0.483	11.68	12.28			
В	0.307	0.323	7.80	8.20			
С	0.030	0.033	0.75	0.85			
D	0.071	0.081	1.80	2.05			
Е	1.488	1.504	37.80	38.20			
F	1.248	1.260	31.70	32.00			
G	0.917	0.957	23.30	24.30			
Н	0.996	1.008	25.30	25.60			
1	0.579	0.602	14.70	15.30			
J	0.492	0.516	12.50	13.10			
K	0.161	0.169	4.10	4.30			
L	0.161	0.169	4.10	4.30			
М	0.181	0.197	4.60	5.00			
N	0.165	0.181	4.20	4.60			
0	1.181	1.197	30.00	30.40			
Q	-0.002	0.004	-0.05	0.10			
R	M4*8						

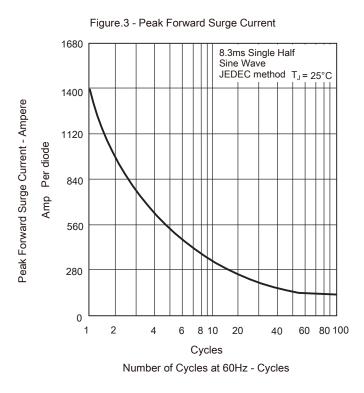
MBRI 2X100 - xxxA

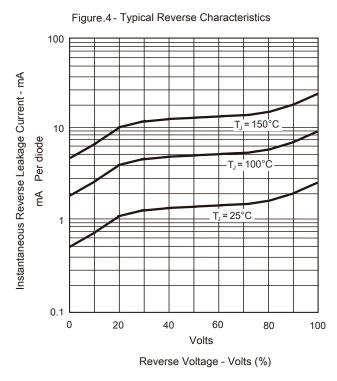


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